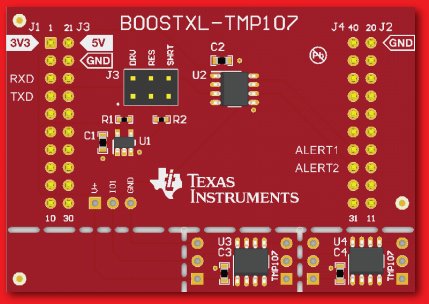
BoosterPack QuickStart Guide (QSG)

Works with TI LaunchPad™

TI BoosterPack™

TMP107 plug-in module for the TI LaunchPad™ development ecosystem

PART NO: BOOSTXL-TMP107



BOOST YOUR DESIGN

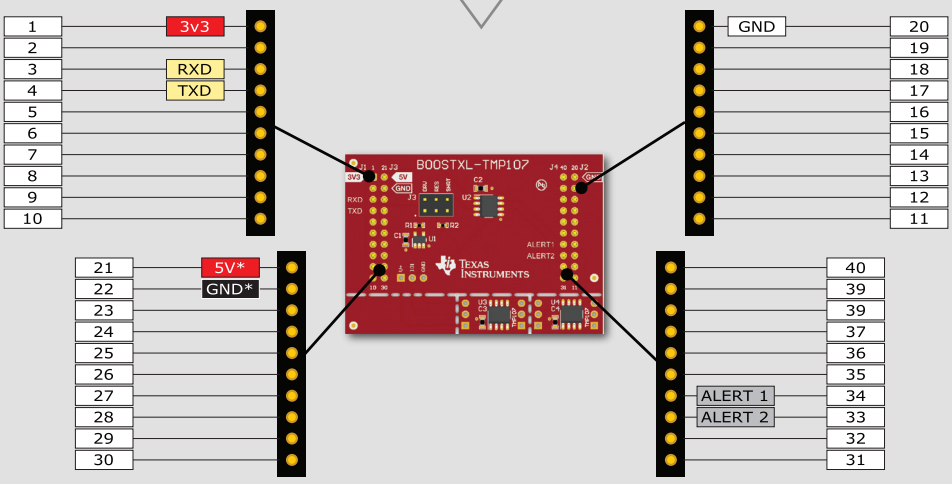
START @ ti.com/tool/boostxl-tmp107

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Explore all BoosterPack™ modules @ www.ti.com/boosterpacks

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